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Dimensions	
Footprint	3528
L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
H	1.9mm +/-0.1mm
T	0.13mm REF
S	0.8mm +/-0.3mm
F	2.2mm +/-0.1mm
A	1.9mm MIN
B	0.4mm +/-0.15mm
P	0.5mm REF
R	1mm REF
X	0.1mm +/-0.1mm REF

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	2000

General Information	
Series	T521
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low ESR, Non-Combustible
Features	Low ESR, High Voltage
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	94.85 mg
Shelf Life	52 Weeks
MSL	3

Specifications	
Capacitance	22 uF
Capacitance Tolerance	20%
Voltage DC	16 VDC (105C)
Temperature Range	-55/+105°C
Rated Temperature	105°C
Life	2000 Hrs (105C)
Humidity	60C, 90% RH, 500 Hours, No Load
Dissipation Factor	8% 120Hz 25C
Failure Rate	N/A
ESR	90 mOhms (100kHz 25C)
Ripple Current	1490 mA (rms, 100kHz 45C), 1043 mA (rms, 85C), 372.5 mA (rms, 105C)
Leakage Current	35.2 uA (5min 25°C)